



DATA SHEET

LOW OHMIC CHIP RESISTORS

RL series 5%, 2%, 1% sizes 0402/0603/0805/1206/ 1210/1218/2010/2512 RoHS compliant & Halogen Free

Product specification – Mar 22, 2010 V.5





YAGEO Phicomp

Chip Resistor Surface Mount RL SERIES 0402 to 2512

<u>SCOPE</u>

This specification describes RL0402 to RL2512 low ohmic chip resistors with lead-free terminations made by thick film process.

APPLICATIONS

- Converters
- Printer equipment
- Server board
- Telecom
- Consumer

FEATURES

- Halogen Free Epoxy
- RoHS compliant
 - Products with lead free terminations meet RoHS requirements
 - Pb-glass contained in electrodes, resistor element and glass are exempted by RoHS
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production
- Low resistances applied to current sensing

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

RL XXXX X X X XX XXXX L

(I)	(2)	(3)	(4)	(5)	(6)	(7)

(I) SIZE

0402 / 0603 / 0805 / 1206 / 1210 / 1218 / 2010 / 2512

(2) TOLERANCE

 $F = \pm 1\%$ $G = \pm 2\%$

 $J = \pm 5\%$

(3) PACKAGING TYPE R = Paper taping reel

K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(5) TAPING REEL

07 = 7 inch dia. Reel

07 – 7 inch dia, Reel

(6) RESISTANCE VALUE

There are $2\sim4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

10 = 10 inch dia. Reel

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter L is system default code for order only ^(Note)

Letter H is Halogen / Lead free (special code on request)

Resistance rule of global part

number	
Resistance code rule	e Example
ORXXX	$ORI = 0.1 \Omega$
-	$0R12 = 0.12 \Omega$
(Ι to 976 mΩ)	$0R105 = 0.105 \Omega$
	$ R = \Omega $
XRXX	irs = 1.5 Ω
(I to 9.76 Ω)	9R76 = 9.76 Ω
XXRX	10R = 10 Ω
(10 to 97.6 Ω)	97R6 = 97.6 Ω
XXXR	$100R = 100 \Omega$
(100 to 976 Ω)	
XKXX	$ K = ,000 \Omega$
(Ι to 9.76 KΩ)	9K76 = 9760 Ω
XMXX	$IM = I,000,000 \Omega$
(1 to 9.76 MΩ)	9M76= 9,760,000 Ω

ORDERING EXAMPLE

The ordering code of a RL0603 chip resistor, value 0.56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RL0603FR-070R56L.

13 = 13 inch dia. Reel

NOTE

- All our RSMD products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol can be printed

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PHYCOMP BRAND ordering codes

Both GLOBAL PART NUMBER (preferred) and I2NC (traditional) codes are acceptable to order Phycomp brand products.

GLOBAL PART NUMBER (PREFERRED)

For detailed information of GLOBAL PART NUMBER and ordering example, please refer to page 2.

12NC CODE

2350	(I) 2390 (I)	2322	-	(2) (3) (4)				Last dig Resistance	git of 12N decade ⁽³		Last digit
SIZE	SIZE TYPE START TOL. RESISTANCE		EMBOSSED ⁽²⁾ TAPE ON REEL	PAPER/PE ⁽⁾ TAPE ON I		0.01 to 0.0 0.1 to 0.97			0		
			(/0)		4,000	5,000	10,000	l to 9.76 9	2		8
0402	LRC31	2350	±5%	0.05 to 1 Ω	-	-	513 20xxx	10 to 97.6	Ω		9
	LRC32	2350	±1%	0.05 to 1 Ω	-	-	513 22xxx	100 to 976	δΩ		
0603	LRC21	2350	±5%	0.01 to 1 Ω	-	512 10xxx	-	l to 9.76 k	Ω		2
	LRC22	2350	±1%	0.01 to 1 Ω	-	512 12xxx	-	10 to 97.6	kΩ		3
0805	LRCII	2350	±5%	0.0 to Ω	-	51110xxx	-	100 to 976			4
	LRC12	2350	±1%	0.01 to 1 Ω	-	51112xxx	-	l to 9.76 N			5
1206	LRC01	2350	±5%	0.01 to 1 Ω	-	51010xxx	-	10 to 97.6 MΩ		6	
	LRC02	2350	±1%	0.01 to 1 Ω	-	51012xxx	-				
1210	LPRC101	2390	±5%	0.01 to 0.0976 Ω	-	735 90xxx	-	Example:	0.02 Ω	=	0200 or 200
	LPRC101	2390	±5%	0.1 to 1 Ω	-	735 60xxx	-		0.3 Ω	=	3007 or 307
	LPRC102	2390	±1%	0.0 to Ω	-	735 3xxxx	-		ΙΩ	=	1008 or 108
1218	LPRC201	2322	±5%	0.0 to Ω	735 64xxx	-	-		33 kΩ	=	3303 or 333
	LPRC201	2322	±1%	0.0 to Ω	735 7xxxx	-	-		10 MΩ	=	1006 or 106
2010	LPRCIII	2322	±5%	0.01 to 0.0976 Ω	760 90xxx	-	-	ORDERIN	G EXAMP	LE	
	LPRCIII	2322	±5%	0.1 to 1 Ω	760 60xxx	-	-	The orderi	ng code c	of a R	RL0603 chip
	LPRCIII	2322	±1%	0.01 to 0.0976 Ω	761 90xxx	-	-	resistor, va			
	LPRCIII	2322	±1%	0. to Ω	761 6xxxx	-	-	tolerance, s			e of 5,000 212567L or
2512	LPRC221	2322	±5%	0.01 to 0.0976 Ω	762 90xxx	-	-	RL0603FR-			
	LPRC221	2322	±5%	0.1 to 1 Ω	762 60xxx	-	-				
	LPRC221	2322	±1%	0.01 to 0.0976 Ω	763 90xxx	-	-	NOTE			. D. 1.12
	LPRC221		±1%	0.1 to 1 Ω	763 6xxxx	-	-	I. All our RS	•		eet RoHS ee. "LFP" of

(1) The resistors have a 12-digit ordering code starting with 2350/2390/2322.

- (2) The subsequent 4 or 5 digits indicate the resistor tolerance and packaging. (In I2NC code, only 07" tape reel code is supplied. Supply of 10"/13" tape reel is requested in Global part number ordering code.)
- (3) The remaining 4 or 3 digits represent the resistance value with the last digit indicating the multiplier as shown in the table of "Last digit of I2NC".
- (4) Letter L is system default code for order only (Note). Letter H is Halogen / Lead free (special code on request).

the internal 2D reel label mentions "Lead Free Process" 2. On customized label, "LFP" or specific symbol can be printed

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Gillp Kesisi	tor Surface Mount RL SERIES 0402 to 2512	
MARKING		
RL0805 / RL1206 / RL1210 /F	RLI218 / RL2010 / RL2512	
	E-24 series / Non-series (R= 25/40/50/60/250/400/500 m Ω): 4 digits	
Fig. I Value = 20 m Ω	The "R" is used as a decimal point; the other 3 digits are significant.	
RL0603: R≥100 mΩ IN E-24	SERIES, R = 10/20/30/40/50/60 mΩ	
	SERIES, R = 10/20/30/40/50/60 mΩ 3 digits	
R22		
	3 digits	
R22 Fig. 2 Value = 22 mΩ	3 digits The "R" is used as a decimal point; the other 2 digits are significant.	
R22 Fig. 2 Value = 22 mΩ	3 digits	
$\mathbf{R22}$ Fig. 2 Value = 22 m Ω	3 digits The "R" is used as a decimal point; the other 2 digits are significant.	

For further marking information, please see special data sheet "Chip resistors marking".

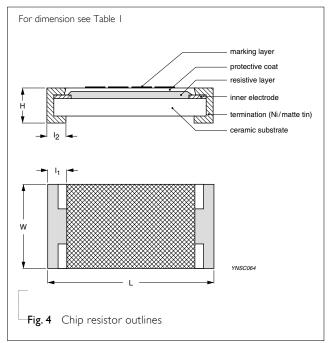
CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the resistance value. Finally, the two external terminations (matte tin) are added. See fig. 4.

DIMENSIONS

TYPE	L (mm)	W (mm)	H (mm)	l₁ (mm)	l₂ (mm)
RL0402	1.00 ±0.10	0.50 ±0.05	0.35 ±0.05	0.20 ±0.10	0.25 ±0.10
RL0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
RL0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20
RL1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20
RL1210	3.10 ±0.10	2.60 ±0.15	0.55 ±0.10	0.50 ±0.20	0.50 ±0.20
RL1218	3.05 ±0.15	4.60 ±0.20	0.55 ±0.10	0.45 ±0.25	0.50 ±0.25
RL2010	5.00 ±0.10	2.50 ±0.15	0.55 ±0.10	0.60 ±0.20	0.50 ±0.20
RL2512	6.35 ±0.10	3.20 ±0.15	0.55 ±0.10	0.60 ±0.20	0.50 ±0.20

OUTLINES



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ELECTRICAL CHARACTERISTICS

Table 2

TYPE / RESISTANCE RANGE	TEMPERATURE COEFFICIENT OF RESISTANCE							
RL0402 ∣00mΩ≤R<∣Ω		I00mΩ≤R<	<500mΩ	2			500mΩ≤R <iω< th=""><th></th></iω<>	
±800 ppm/°C				±300 ppm/°C				
RL0603 ∣0mΩ≤R<ΙΩ	I0mΩ≤R≤36	δmΩ	36	mΩ <r< th=""><th>.≤9ImΩ</th><th>91mΩ<i< th=""><th>R≤500mΩ</th><th>500mΩ<r<iω< th=""></r<iω<></th></i<></th></r<>	.≤9ImΩ	91mΩ <i< th=""><th>R≤500mΩ</th><th>500mΩ<r<iω< th=""></r<iω<></th></i<>	R≤500mΩ	500mΩ <r<iω< th=""></r<iω<>
	±1,500 ppm	±1,500 ppm/°C ±1,2		1,200 p	opm/°C	±800	ppm/°C	±300 ppm/°C
	I0mΩ≤R≤I8mΩ	I8mΩ <r≤< th=""><th>47mΩ</th><th>47mû</th><th>Ω<r≤9imω< th=""><th>91mΩ<r≤360mω< th=""><th>360mΩ<r≤500mω< th=""><th>500mΩ<r<iω< th=""></r<iω<></th></r≤500mω<></th></r≤360mω<></th></r≤9imω<></th></r≤<>	47mΩ	47mû	Ω <r≤9imω< th=""><th>91mΩ<r≤360mω< th=""><th>360mΩ<r≤500mω< th=""><th>500mΩ<r<iω< th=""></r<iω<></th></r≤500mω<></th></r≤360mω<></th></r≤9imω<>	91mΩ <r≤360mω< th=""><th>360mΩ<r≤500mω< th=""><th>500mΩ<r<iω< th=""></r<iω<></th></r≤500mω<></th></r≤360mω<>	360mΩ <r≤500mω< th=""><th>500mΩ<r<iω< th=""></r<iω<></th></r≤500mω<>	500mΩ <r<iω< th=""></r<iω<>
RL0805	±1,500 ppm/°C	±1,200 pp	m/°C	±1,0	00 ppm/°C	±600 ppm/°C	±300 ppm/°C	±200 ppm/°C
<u>RLI206</u> I0mΩ≤R <iω< th=""><th>±1,500 ppm/°C</th><th>±1,200 pp</th><th>m/°C</th><th>±1,0</th><th>00 ppm/°C</th><th>±600 ppm/°C</th><th>±300 ppm/°C</th><th>±200 ppm/°C</th></iω<>	±1,500 ppm/°C	±1,200 pp	m/°C	±1,0	00 ppm/°C	±600 ppm/°C	±300 ppm/°C	±200 ppm/°C
RLI2I0	±1,500 ppm/°C	±1,000 pp	om∕°C	±80)0 ppm/°C	±600 ppm/°C	±300 ppm/°C	±200 ppm/°C
RL2010	±1,500 ppm/°C	±1,200 pp	om∕°C	±1,0	00 ppm/°C	±600 ppm/°C	±300 ppm/°C	±200 ppm/°C
RL2512	±1,500 ppm/°C	±1,200 pp	m/°C	±80)0 ppm/°C	±600 ppm/°C	±300 ppm/°C	±200 ppm/°C
RLI2I8 ∣0mΩ≤R<ΙΩ	I0mΩ≤R≤30mΩ	Ω 30mΩ	? <r≤56< th=""><th>mΩ</th><th>56mΩ<r≤< th=""><th>I 80mΩ</th><th>180mΩ<r<1ω< th=""><th>2</th></r<1ω<></th></r≤<></th></r≤56<>	mΩ	56mΩ <r≤< th=""><th>I 80mΩ</th><th>180mΩ<r<1ω< th=""><th>2</th></r<1ω<></th></r≤<>	I 80mΩ	180mΩ <r<1ω< th=""><th>2</th></r<1ω<>	2
	±2,000 ppm/°C	±1,00)0 ppm	/°C	±700 pp	m/°C	±250 ppm/°C	

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

 Table 3
 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	RL0402	RL0603	RL0805	RL1206	RL1210	RL1218	RL2010	RL2512
Paper taping reel (R)	7" (178 mm)	10,000	5,000	5,000	5,000	5,000			
	10" (254 mm)	20,000	10,000	10,000	10,000	10,000			
	13" (330 mm)	50,000	20,000	20,000	20,000	20,000			
Embossed taping reel (K)	7" (178 mm)						4,000	4,000	4,000

ΝΟΤΕ

I. For paper/embossed tape and reel specification/dimensions, please see the special data sheet "Chip resistors packing".

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FUNCTIONAL DESCRIPTION

OPERATINGTEMPERATURE RANGE

Range: -55 °C to +125 °C

POWER RATING

Each type rated power at 70 °C: RL0402=1/16 W; RL0603=1/10 W; RL0805=1/8 W; RL1206=1/4 W; RL1210=1/2 W; RL1218=1 W; RL2010=3/4 W; RL2512=1 W.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

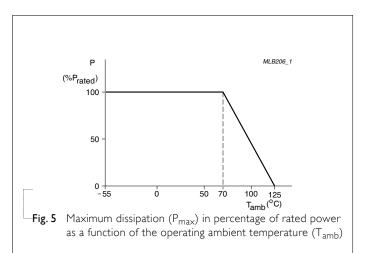
$$V = \sqrt{P \times R}$$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$



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TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/ Endurance	IEC 60115-1 4.25.1	I,000 hours at 70±5 °C applied RCWV I.5 hours on, 0.5 hour off, still air required	±2%
High Temperature Exposure/ Endurance at upper	IEC 60068-2-2	I,000 hours at maximum operating temperature depending on specification, unpowered	±1%
category temperature		No direct impingement of forced air to the parts	
		Tolerances: 125±5 °C	
Moisture Resistance	MIL-STD-202G Method-106G	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±2%
		Parts mounted on test-boards, without condensation on parts	
		Measurement at 24±2 hours after test conclusion	
Thermal Shock	MIL-STD-202G Method-107G	-55/+125 °C	±1%
		Note: Number of cycles required is 300. Devices unmounted	
		Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	
Short time overload	IEC60115-1 4.13	2.5 times RCWV or maximum overload voltage whichever is less for 5 sec at room temperature	±2% No visible damage
Board Flex/	IEC 60068-2-21	Device mounted on PCB test board as	±1%
Bending		described, only I board bending required	No visible damage
		3 mm bending Bending time: 60±5 seconds	
		Ohmic value checked during bending	

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability			
- Wetting	IPC/JEDECJ-STD-002B test B	Electrical Test not required	Well tinned (≥95% covered)
		Magnification 50X	No visible damage
		SMD conditions:	
		I st step: method B, aging 4 hours at 155 °C dry heat	
		2^{nd} step: leadfree solder bath at 245±3 °C	
		Dipping time: 3±0.5 seconds	
- Leaching	IPC/JEDECJ-STD-002B test D	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
- Resistance to	IEC 60068-2-58	Condition B, no pre-heat of samples.	±1%
Soldering Heat		Leadfree solder, 260 °C, 10 seconds immersion time	No visible damage
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	

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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 5	Mar 22, 2010	-	- The statement of "Halogen Free" on the cover added
			- Test methods updated
Version 4	Dec 11, 2008	-	- Halogen Free Epoxy
			- Update global part number definition
Version 3	Aug 07, 2008	-	- Change to dual brand datasheet that describe RL0402 to RL2512 with RoHS compliant
			- Define global part number
Version 2	Jul 15, 2005	-	- Ordering example revised
Version I	Apr 15, 2005	-	- Size 1218 extended
			- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)
Version 0	Nov. 10, 2003	-	- First issue of this specification

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